

Description

The 74HC164 is a serial input 8-bit edge-triggered shift register that has outputs from each of eight stages.

SERIAL DATA INPUT PINS

The serial input data is entered at pin SDA or pin SDB as these are logically ANDED. Either input could be used as an active HIGH enable with data entry on the other pin. If a single input is desired, the pins can be tied together or the unused input can be tied HIGH.

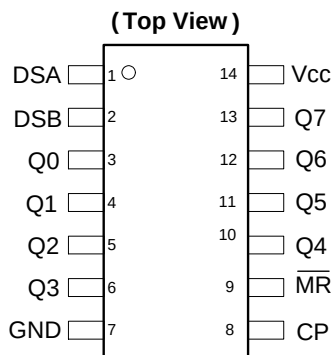
DATA ENTRY

Data is shifted into Q0 from the serial input pins on each LOW to HIGH transition of the CP pin. Also during the CP edge the data is transferred from each Qn to Qn+1. The serial data on pins SDA and SDB must be stable before and after the CP rising edge to meet the set-up and hold timing requirements.

RESET

When asserted LOW the Master Reset ($\overline{\text{MR}}$) pin sets all Qn to LOW. This action does not depend on the condition of serial input or clock pins. The $\overline{\text{MR}}$ must be asserted HIGH for a recovery time before the next CP positive edge pulse.

Pin Assignments



SO-14 / TSSOP-14 / PDIP-14

Features

- Wide Supply Voltage Range from 2.0V to 6.0V
- Sinks or Sources 4mA at $V_{CC} = 4.5V$
- CMOS Low Power Consumption
- Schmitt Trigger Action at all Inputs
- ESD Protection Exceeds JESD 22
 - 200-V Machine Model (A115)
 - 2000-V Human Body Model (A114)
 - Exceeds 1000-V Charged Device Model (C101)
- Range of Package Options SO-14 and TSSOP-14
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

Applications

- General Purpose Logic
- Wide Array of Products Such as:
 - PCs, Networking, Notebooks, Netbooks
 - Computer Peripherals, Hard Drives, CD/DVD ROM
 - TV, DVD, DVR, Set-Top Box

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Device Ordering Information is on Page 7

Pin Descriptions

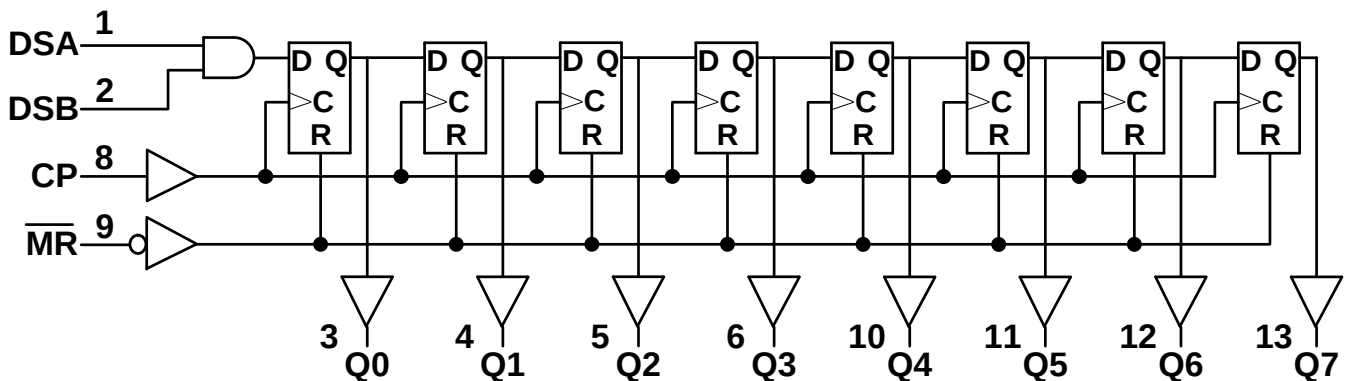
Pin Number	Pin Name	Function
1	DSA	Serial Data Input
2	DSB	Serial Data Input
3	Q0	Data Output
4	Q1	Data Output
5	Q2	Data Output
6	Q3	Data Output
7	GND	Ground
8	CP	Clock Pulse –Positive Edge Triggered
9	$\overline{\text{MR}}$	Master Reset - Asynchronous
10	Q4	Data Output
11	Q5	Data Output
12	Q6	Data Output
13	Q7	Data Output
14	V _{CC}	Supply Voltage

Function Table (Note 4)

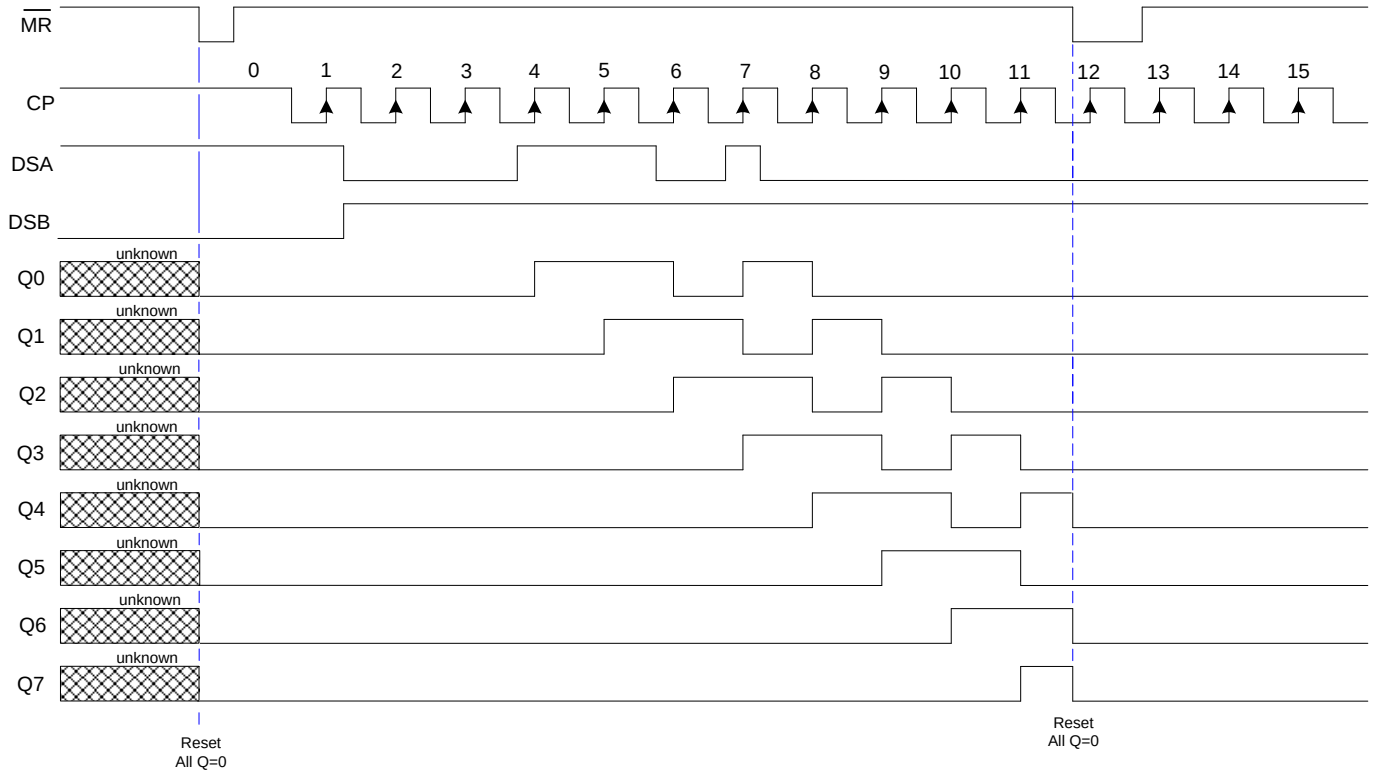
Mode	Input				Output	
	$\overline{\text{MR}}$	CP	DSA	DSB	Q0	Q1-Q7
Reset	L	X	X	X	L	L
Shift	H	$\uparrow$	L	X	L	$Q_n \leftarrow Q_{n-1}$ (n= 1 to7)
	H	$\uparrow$	X	L	L	$Q_n \leftarrow Q_{n-1}$ (n= 1 to7)
	H	$\uparrow$	H	H	H	$Q_n \leftarrow Q_{n-1}$ (n= 1 to7)

Note: 4. Signals asserted on DSA and DSB must be in place longer than Tsu (set-up time) before CP occurs and remain in place Thold (hold time) after CP.

Logic Diagram



Timing Diagram



- Notes:
5. All Q values are reset to LOW when $\overline{MR}$ goes low. $\overline{MR}$ is asynchronous and overrides all other signals.
 6. Serial data supplied at DSA and DSB is ANDED and transferred to $Q0$ on positive edge of CP .

Absolute Maximum Ratings (Note 7) ($T_A = +25^\circ\text{C}$, unless otherwise specified.)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	kV
ESD CDM	Charged Device Model ESD Protection	1	kV
ESD MM	Machine Model ESD Protection	200	V
V_{CC}	Supply Voltage Range	-0.5 to +7.0	V
V_I	Input Voltage Range (Note 8)	-0.5 to +7.0	V
I_{IK}	Input Clamp Current $V_I < -0.5\text{V}$ or $V_I > V_{CC} + 0.5\text{V}$	± 20	mA
I_{OK}	Output Clamp Current $V_O < -0.5\text{V}$ or $V_O > V_{CC} + 0.5\text{V}$	± 20	mA
I_O	Continuous Output Current $-0.5\text{V} < V_O < V_{CC} + 0.5\text{V}$	± 25	mA
I_{CC}	Continuous Current through V_{CC}	50	mA
I_{GND}	Continuous Current through GND	-50	mA
T_J	Operating Junction Temperature	-40 to +150	$^\circ\text{C}$
T_{STG}	Storage Temperature	-65 to +150	$^\circ\text{C}$
P_{TOT}	Total Power Dissipation	500	mW

- Notes:
7. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.
 8. Input Voltage cannot exceed V_{CC} to the extent the maximum clamp current is exceeded.

Recommended Operating Conditions (Note 9) ($T_A = +25^\circ\text{C}$, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	Supply Voltage	—	2.0	6.0	V
V_I	Input Voltage	—	0	V_{CC}	V
V_O	Output Voltage	—	0	V_{CC}	V
$\Delta t/\Delta V$	Input Transition Rise or Fall Rate	$V_{CC} = 2.0\text{V}$	—	625	ns/V
		$V_{CC} = 4.5\text{V}$	—	140	
		$V_{CC} = 6.0\text{V}$	—	85	
T_A	Operating Free-Air Temperature	—	-40	+125	$^\circ\text{C}$

 Note: 9. Unused inputs should be held at V_{CC} or Ground.

Electrical Characteristics ($T_A = +25^\circ\text{C}$, unless otherwise specified.)

Symbol	Parameter	Test Conditions	V_{CC}	$T_A = +25^\circ\text{C}$			$T_A = -40^\circ\text{C to } +85^\circ\text{C}$		$T_A = -40^\circ\text{C to } +125^\circ\text{C}$		Unit
				Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
V_{IH}	High-level Input Voltage	—	2.0V	1.5	1.2	—	1.5	—	1.5	—	V
		—	4.5V	3.15	2.4	—	3.15	—	3.15	—	
		—	6.0V	4.2	3.2	—	4.2	—	4.2	—	
V_{IL}	Low-level Input Voltage	—	2.0V	—	0.8	0.5	—	0.5	—	0.5	V
		—	4.5V	—	2.1	1.35	—	1.35	—	1.35	
		—	6.0V	—	2.8	1.8	—	1.8	—	1.8	
V_{OH}	High-level Output Voltage	$I_{OH} = -20\mu\text{A}$	2.0V	1.9	2.0	—	1.9	—	1.9	—	V
		$I_{OH} = -20\mu\text{A}$	4.5V	4.4	4.5	—	4.4	—	4.4	—	
		$I_{OH} = -20\mu\text{A}$	6.0V	5.9	6.0	—	5.9	—	5.9	—	
		$I_{OH} = -4.0\text{mA}$	4.5V	3.98	4.32	—	3.84	—	3.7	—	
		$I_{OH} = -5.2\text{mA}$	6.0V	5.48	5.81	—	5.34	—	5.2	—	
V_{OL}	Low-level Output Voltage	$I_{OL} = 20\mu\text{A}$	2.0V	—	0	0.1	—	0.1	—	0.1	V
		$I_{OL} = 20\mu\text{A}$	4.5V	—	0	0.1	—	0.1	—	0.1	
		$I_{OL} = 20\mu\text{A}$	6.0V	—	0	0.1	—	0.1	—	0.1	
		$I_{OL} = 4\text{mA}$	4.5V	—	0.15	0.26	—	0.33	—	0.4	
		$I_{OL} = 5.2\text{mA}$	6.0V	—	0.15	0.26	—	0.33	—	0.4	
I_I	Input Current	$V_I = \text{GND or } V_{CC}$	6.0V	—	—	± 0.1	—	± 1	—	± 1	μA
I_{CC}	Supply Current	$V_I = \text{GND or } V_{CC}, I_O = 0\text{A}$	6.0V	—	—	8.0	—	80	—	160	μA

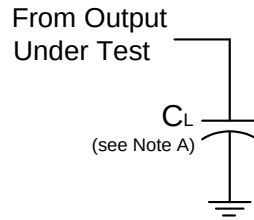
Switching Characteristics

Symbol / Parameter	Pins	Test Conditions	V _{CC}	T _A = +25°C			-40°C to +85°C		-40°C to +125°C		Unit
				Min	Typ.	Max	Min	Max	Min	Max	
f _{MAX} Maximum Frequency	CP	Figure 1	2.0 V	6	23	—	5	—	4	—	MHz
			4.5 V	30	71	—	24	—	20	—	
			5.0 V	—	78	—	—	—	—	—	
			6.0 V	35	85	—	28	—	24	—	
t _w Pulse Width	CP HIGH or LOW	Figure 1	2.0 V	80	14	—	100	—	120	—	ns
			4.5 V	16	5	—	20	—	24	—	
			6.0 V	14	4	—	17	—	20	—	
	MR LOW	Figure 1	2.0 V	60	17	—	75	—	90	—	ns
			4.5 V	12	6	—	15	—	18	—	
			6.0 V	10	5	—	13	—	15	—	
t _{SU} Set-up Time	DSA or DSB to CP	Figure 1	2.0 V	60	8	—	75	—	90	—	ns
			4.5 V	12	3	—	15	—	18	—	
			6.0 V	10	2	—	13	—	15	—	
t _H Hold Time	DSA or DSB to CP	Figure 1	2.0 V	4	-6	—	4	—	4	—	ns
			4.5 V	4	-2	—	4	—	4	—	
			6.0 V	4	-2	—	4	—	4	—	
t _{PD} Propagation Delay	CP to Qn	Figure 1	2.0 V	—	41	170	—	215	—	255	ns
			4.5 V	—	15	34	—	43	—	51	
			5.0 V	—	12	—	—	—	—	—	
			6.0 V	—	12	29	—	37	—	43	
t _{rec} Recovery Time	MR to CP		2.0 V	60	17	—	75	—	90	—	ns
			4.5 V	12	6	—	15	—	18	—	
			6.0 V	10	5	—	13	—	15	—	
t _{PHL} HIGH to LOW Propagation Delay	MR to Qn	Figure 1	2.0 V	—	39	140	—	175	—	210	ns
			4.5 V	—	14	28	—	35	—	42	
			5.0 V	—	11	—	—	—	—	—	
			6.0 V	—	11	24	—	30	—	36	
t _T Transition Time	All signals	Figure 1	2.0 V	—	19	75	—	95	—	110	ns
			4.5 V	—	7	15	—	19	—	22	
			6.0 V	—	6	13	—	16	—	19	

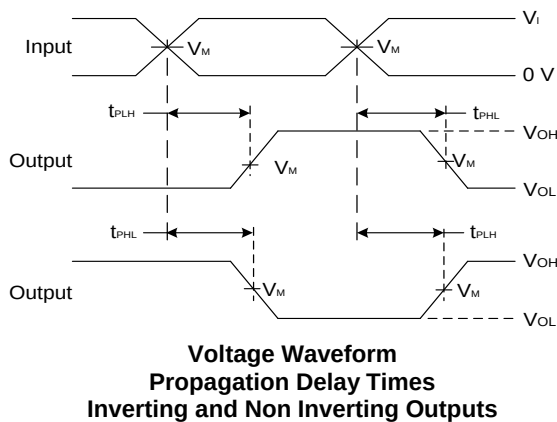
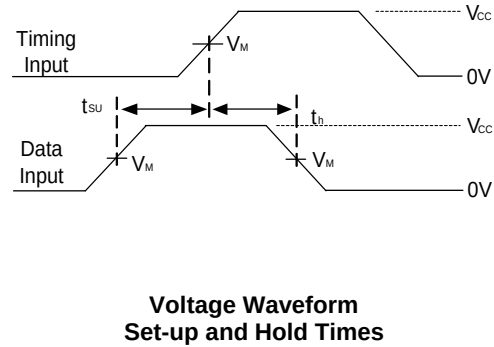
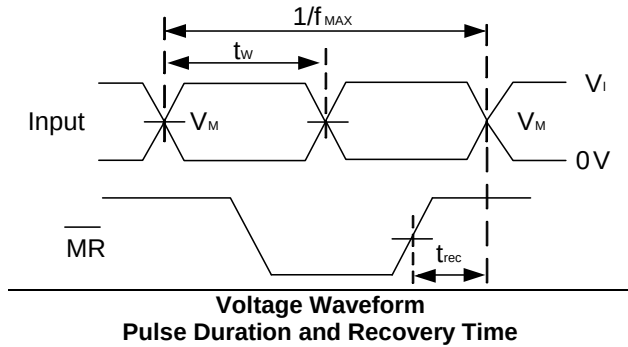
Operating Characteristics (@T_A = +25°C, unless otherwise specified.)

Parameter		Test Conditions	V _{CC} = 6V	Unit
			Typ	
C _{pd}	Power Dissipation Capacitance per Gate	f = 1 MHz	40	pF
C _I	Input Capacitance	V _I = V _{CC} – or GND	3.5	pF

Parameter Measurement Information



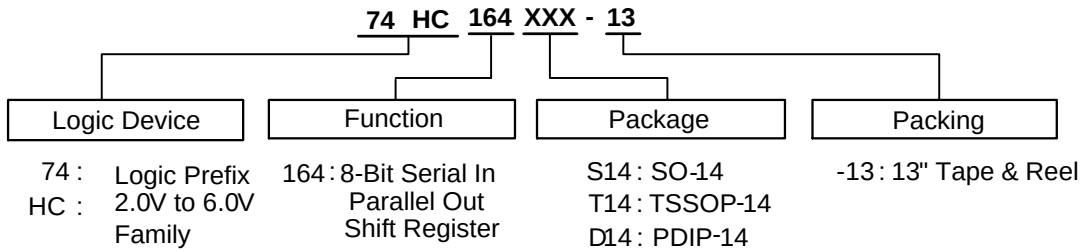
V_{CC}	Inputs		V_M	C_L
	V_I	t_r/t_f		
2.0V	V_{CC}	6ns	$V_{CC}/2$	50pF
4.5V	V_{CC}	6ns	$V_{CC}/2$	50pF
5.0V	V_{CC}	6ns	$V_{CC}/2$	15pF
6.0V	V_{CC}	6ns	$V_{CC}/2$	50pF



- Notes:
- A. Includes test lead and test apparatus capacitance.
 - B. All pulses are supplied at pulse repetition rate ≤ 10 MHz.
 - C. Inputs are measured separately, one transition per measurement.
 - D. t_{PLH} and t_{PHL} are the same as t_{PD} .
 - E. Transition times t_r , t_{th} , t_{tl} are measured from the 10% to 90% or 90% to 10% of the appropriate waveform.

Figure 1 Load Circuit and Voltage Waveforms

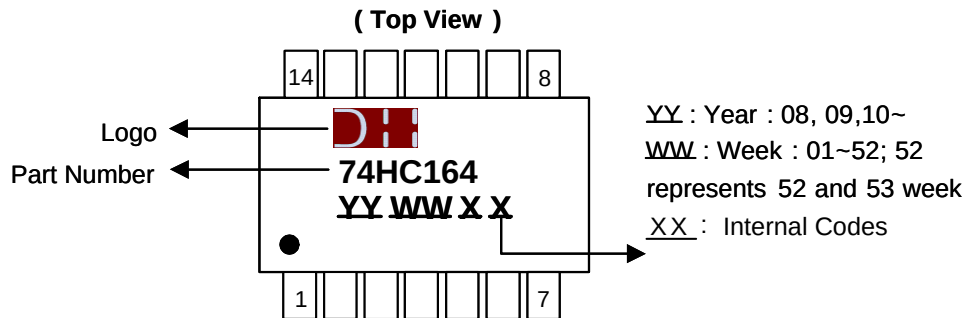
Ordering Information



Device	Package Code	Packaging	Packing	
			Quantity	Part Number Suffix
74HC164S14-13	S14	SO-14	2,500/Tape & Reel	-13
74HC164T14-13	T14	TSSOP-14	2,500/Tape & Reel	-13
74HC164D14	D14	PDIP-14	TUBE	No Suffix

Marking Information

(1) SO-14, TSSOP-14, PDIP-14

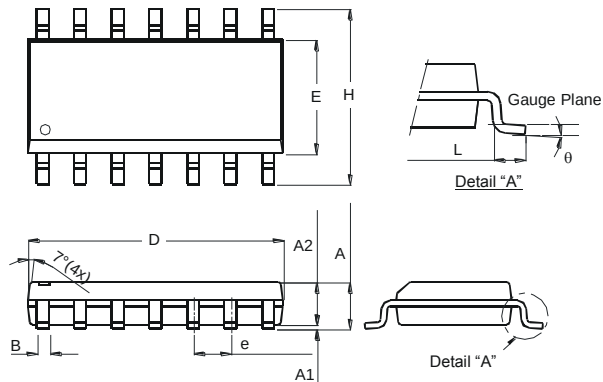


Part Number	Package
74HC164S14-13	SO-14
74HC164T14-13	TSSOP-14
74HC164D14	PDIP-14

Package Outline Dimensions (All dimensions in mm.)

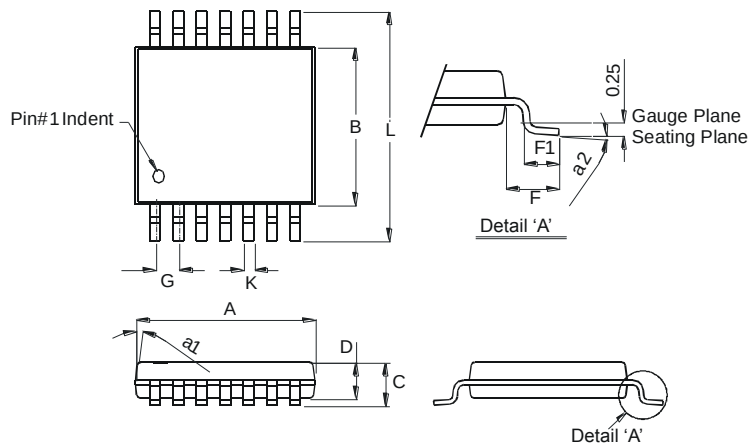
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.

Package Type: SO-14



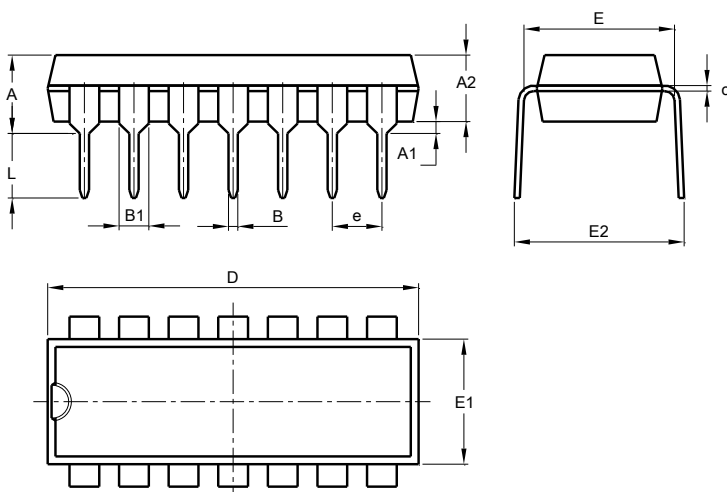
SO-14		
Dim	Min	Max
A	1.47	1.73
A1	0.10	0.25
A2	1.45 Typ	
B	0.33	0.51
D	8.53	8.74
E	3.80	3.99
e	1.27 Typ	
H	5.80	6.20
L	0.38	1.27
θ	0°	8°
All Dimensions in mm		

Package Type: TSSOP-14



TSSOP-14		
Dim	Min	Max
a1	7° (4X)	
a2	0°	8°
A	4.9	5.10
B	4.30	4.50
C	—	1.2
D	0.8	1.05
F	1.00 Typ	
F1	0.45	0.75
G	0.65 Typ	
K	0.19	0.30
L	6.40 Typ	
All Dimensions in mm		

Package Type: PDIP-14

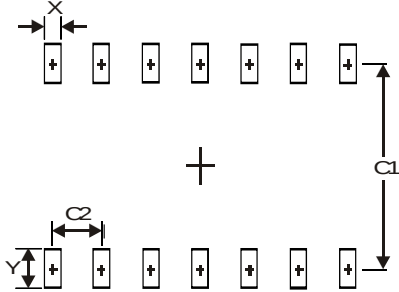


PDIP-14		
Dim	Min	Max
A	3.710	4.310
A1	0.510	-
A2	3.200	3.600
B	0.380	0.570
B1	1.524 (BSC)	
c	0.204	0.360
D	18.800	19.200
E	6.200	6.600
E1	7.320	7.920
E2	8.400	9.000
e	2.540 (BSC)	
L	3.000	3.600
All Dimensions in mm		

Suggested Pad Layout

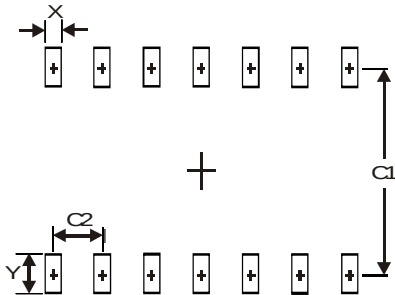
Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.

Package Type: SO-14



Dimensions	Value (in mm)
X	0.60
Y	1.50
C1	5.4
C2	1.27

Package Type: TSSOP-14



Dimensions	Value (in mm)
X	0.45
Y	1.45
C1	5.9
C2	0.65

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